

# FXLP34 Single Bit Uni-Directional Translator

#### **Features**

- 1.0V to 3.6V V<sub>CC</sub> supply operation
- Converts any voltage (1.0V to 3.6V) to (1.0V to 3.6V)
- 4.6V tolerant inputs and outputs
- t<sub>PD</sub>

4ns typ. for 3.0V to 3.6V  $\rm V_{CC}$  5ns typ. for 2.3V to 2.7V  $\rm V_{CC}$  6ns typ. for 1.65V to 1.95V  $\rm V_{CC}$  7ns typ. for 1.40V to 1.60V  $\rm V_{CC}$  11ns typ. for 1.10V to 1.30V  $\rm V_{CC}$  27ns typ. for 1.0V  $\rm V_{CC}$ 

- Power-off high impedance inputs and outputs
- Static Drive (I<sub>OH</sub>/I<sub>OL</sub>)

±2.6mA @ 3.00V V<sub>CC</sub>

±2.1mA @ 2.30V V<sub>CC</sub>

±1.5mA @ 1.65V V<sub>CC</sub>

±1.0mA @ 1.40V V<sub>CC</sub>

±0.5mA @ 1.10V V<sub>CC</sub>

±20μA@ 1.0V V<sub>CC</sub>

- Uses patented Quiet Series<sup>™</sup> noise/EMI reduction circuitry
- Ultra small MicroPak<sup>™</sup> leadless package
- Ultra low dynamic power

#### **General Description**

The FXLP34 is a single translator with two separate supply voltages:  $V_{CC1}$  for input translation voltages and  $V_{CC}$  for output translation voltages. The FXLP34 is part of Fairchild's Ultra Low Power (ULP) series of products. This device operates with  $V_{CC}$  values from 1.0V to 3.6V, and is intended for use in portable applications that require ultra low power consumption.

The internal circuit is composed of a minimum of buffer stages, to enable ultra low dynamic power.

The FXLP34 is uniquely designed for optimized power and speed, and is fabricated with an advanced CMOS technology to achieve high-speed operation while maintaining low CMOS power dissipation.

## **Ordering Information**

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
FXLP34P5X	MAA05A	X34	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3k Units on Tape and Reel
FXLP34L6X	MAC06A	X3	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

MicroPak<sup>™</sup> and Quiet Series<sup>™</sup> are trademarks of Fairchild Semiconductor Corporation.

# **Pin Descriptions**

Pin Names	Description			
A	Input			
Y	Output			
NC	No Connect			
V <sub>CC1</sub>	Input Translation Voltage			
V <sub>CC</sub>	Output Translation Voltage			

## **Function Table**

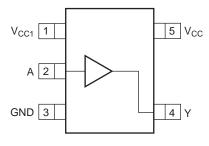
v		
T		$\mathbf{A}$
	_	, ,

Inputs	Output
Α	Υ
L	L
Н	Н

H = HIGH Logic Level L = LOW Logic Level

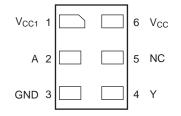
# **Connection Diagrams**

## Pin Assignments for SC70



(Top View)

## Pin Assignments for MicroPak



(Top Thru View)

## **Absolute Maximum Ratings**

The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Symbol	Parameter	Rating
V <sub>CC</sub> , V <sub>CC1</sub>	Supply Voltage	-0.5V to +4.6V
V <sub>IN</sub>	DC Input Voltage	-0.5V to +4.6V
V <sub>OUT</sub>	DC Output Voltage HIGH or LOW State <sup>(1)</sup> V <sub>CC</sub> = 0V	-0.5V to V <sub>CC</sub> +0.5V -0.5V to 4.6V
I <sub>IK</sub>	DC Input Diode Current V <sub>IN</sub> < 0V	±50mA
I <sub>OK</sub>	DC Output Diode Current V <sub>OUT</sub> < 0V V <sub>OUT</sub> > V <sub>CC</sub>	-50mA +50mA
I <sub>OH</sub> /I <sub>OL</sub>	DC Output Source/Sink Current	±50mA
I <sub>CC</sub> or Ground	DC V <sub>CC</sub> or Ground Current per Supply Pin	±100mA
T <sub>STG</sub>	Storage Temperature Range	-65°C to +150°C

# Recommended Operating Conditions<sup>(2)</sup>

Symbol	Parameter	Rating
V <sub>CC</sub> , V <sub>CC1</sub>	Supply Voltage	1.0V to 3.6V
V <sub>IN</sub>	Input Voltage	0.0V to 3.6V
V <sub>OUT</sub>	Output Voltage HIGH or LOW State V <sub>CC</sub> = 0V	0V to V <sub>CC</sub> 0V to 3.6V
	Output Current in $I_{OH}/I_{OL}$ $V_{CC} = 3.0V$ to $3.6V$ $V_{CC} = 2.3V$ to $2.7V$ $V_{CC} = 1.65V$ to $1.95V$ $V_{CC} = 1.40V$ to $1.60V$ $V_{CC} = 1.10V$ to $1.30V$ $V_{CC} = 1.0V$	±2.6 mA ±2.1mA ±1.5mA ±1.0mA ±0.5mA ±20µA
T <sub>A</sub>	Free Air Operating Temperature	-40°C to +85°C
$\Delta t/\Delta V$	Minimum Input Edge Rate, V <sub>IN</sub> = 0.8V to 2.0V, V <sub>CC1</sub> = 3.0V	10ns/V

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#### Notes:

- 1. I<sub>O</sub> Absolute Maximum Rating must be observed.
- 2. Unused inputs must be held HIGH or LOW. They may not float.

# **DC Electrical Characteristics**

					$T_A = -$	+25°C	$T_A = -40^{\circ}C$	C to +85°C	
Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	V <sub>CC1</sub> (V)	Min.	Max.	Min.	Max.	Units
V <sub>IH</sub>	HIGH Level Input Voltage (V <sub>CC1</sub> )		1.0 to 3.6	$\begin{array}{c} 1.0 \\ 1.10 \leq V_{CC1} \leq 1.30 \\ 1.40 \leq V_{CC1} \leq 1.60 \\ 1.65 \leq V_{CC1} \leq 1.95 \\ 2.30 \leq V_{CC1} \leq 2.70 \\ 3.00 \leq V_{CC1} \leq 3.60 \end{array}$	0.65 x V <sub>CC1</sub>	-	0.65 x V <sub>CC1</sub> 0.65 x V <sub>CC1</sub> 0.65 x V <sub>CC1</sub> 0.65 x V <sub>CC1</sub> 1.6 2.1	-	V
V <sub>IL</sub>	LOW Level Input Voltage		1.0 to 3.6	$\begin{array}{c} 1.0 \\ 1.10 \leq V_{CC1} \leq 1.30 \\ 1.40 \leq V_{CC1} \leq 1.60 \\ 1.65 \leq V_{CC1} \leq 1.95 \\ 2.30 \leq V_{CC1} \leq 2.70 \\ 3.00 \leq V_{CC1} \leq 3.60 \end{array}$	-	0.35 x V <sub>CC1</sub> 0.35 x V <sub>CC1</sub> 0.35 x V <sub>CC1</sub> 0.35 x V <sub>CC1</sub> 0.7 0.9	-	0.35 x V <sub>CC1</sub> 0.35 x V <sub>CC1</sub> 0.35 x V <sub>CC1</sub> 0.35 x V <sub>CC1</sub> 0.7 0.9	V
V <sub>OH</sub>	HIGH Level Output Voltage (V <sub>CC</sub> )	Ι <sub>ΟΗ</sub> = -20μΑ	$\begin{array}{c} 1.0 \\ 1.10 \leq V_{CC1} \leq 1.30 \\ 1.40 \leq V_{CC1} \leq 1.60 \\ 1.65 \leq V_{CC1} \leq 1.95 \\ 2.30 \leq V_{CC1} \leq 2.70 \\ 3.00 \leq V_{CC1} \leq 3.60 \end{array}$	1.0 to 3.6	V <sub>CC</sub> - 0.1 V <sub>CC</sub> - 0.1	-	V <sub>CC</sub> - 0.1 V <sub>CC</sub> - 0.1	-	V
		I <sub>OH</sub> = -0.5mA	1.10 ≤ V <sub>CC</sub> ≤ 1.30	1.0 to 3.6	0.75 x V <sub>CC</sub>	-	0.70 x V <sub>CC</sub>	-	
		I <sub>OH</sub> = -1.0mA	1.40 ≤ V <sub>CC</sub> ≤ 1.60	1.0 to 3.6	1.07	-	0.99	-	
		I <sub>OH</sub> = -1.5mA	1.65 ≤ V <sub>CC</sub> ≤ 1.95	1.0 to 3.6	1.24	-	1.22	-	
		I <sub>OH</sub> = -2.1mA	$2.30 \le V_{CC} \le 2.70$	1.0 to 3.6	1.95	_	1.87	_	
		I <sub>OH</sub> = -2.6mA	$3.00 \le V_{CC} \le 3.60$	1.0 to 3.6	2.61	-	2.55	_	1
V <sub>OL</sub>	LOW Level Output Voltage	I <sub>OL</sub> = 20μA	$\begin{array}{c} 1.0 \\ 1.10 \leq V_{CC1} \leq 1.30 \\ 1.40 \leq V_{CC1} \leq 1.60 \\ 1.65 \leq V_{CC1} \leq 1.95 \\ 2.30 \leq V_{CC1} \leq 2.70 \\ 3.00 \leq V_{CC1} \leq 3.60 \end{array}$	1.0 to 3.6	-	0.1 0.1 0.1 0.1 0.1 0.1	-	0.1 0.1 0.1 0.1 0.1 0.1	V
		I <sub>OL</sub> = 0.5mA	1.10 ≤ V <sub>CC</sub> ≤ 1.30	1.0 to 3.6	_	0.30 x V <sub>CC</sub>	_	0.30 x V <sub>CC</sub>	1
		I <sub>OL</sub> = 1.0mA	1.40 ≤ V <sub>CC</sub> ≤ 1.60	1.0 to 3.6	_	0.31	_	0.37	1
		I <sub>OL</sub> = 1.5mA	1.65 ≤ V <sub>CC</sub> ≤ 1.95	1.0 to 3.6	_	0.31	_	0.35	1
		I <sub>OL</sub> = 2.1mA	2.30 ≤ V <sub>CC</sub> ≤ 2.70	1.0 to 3.6	_	0.31	_	0.33	1
		I <sub>OL</sub> = 2.6mA	3.00 ≤ V <sub>CC</sub> ≤ 3.60	1.0 to 3.6	_	0.31	_	0.33	1
I <sub>IN</sub>	Input Leakage Current	$0 \le V_1 \le 3.6V$		1.0 to 3.60	-	±0.1	_	±1.0	μΑ
l <sub>OFF</sub>	Power Off Leakage Current	0 ≤ (V <sub>I</sub> , V <sub>O</sub> ) ≤ 3.6V	0	0	-	1.0	_	5.0	μА
I <sub>CC</sub>	Quiescent Supply Current	V <sub>I</sub> = V <sub>CC</sub> or GND	1.0 to 3.60	1.0 to 3.6	-	0.9	-	5.0	μА

# **AC Electrical Characteristics**

					$T_A = +25^{\circ}C$	C	$T_A = -40^{\circ}C$	C to +85°C		Figure
Symbol	Parameter	Conditions	V <sub>CC1</sub> (V)	Min.	Тур.	Max.	Min.	Max.	Units	Number
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay Output Translation V <sub>CC</sub> (V) = 1.0	$C_L = 10pF$ $R_L = 1M\Omega$	1.0 1.10 to 1.30 1.40 to 1.60 1.65 to 1.95	15.0 14.0 13.0	26.0 25.0 24.0 23.0	38.1 36.7 36.0	12.0 11.0 10.0	43.3 42.0 41.4	ns	Figure 1 Figure 2
			2.30 to 2.70 3.00 to 3.60	12.0 11.0	22.0 21.0	35.5 35.5	9.0 8.0	40.9 40.6		
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay Output Translation V <sub>CC</sub> (V) = 1.2	$C_L = 10pF$ $R_L = 1M\Omega$	1.0 1.10 to 1.30 1.40 to 1.60 1.65 to 1.95 2.30 to 2.70 3.00 to 3.60	8.0 7.5 7.0 6.5 6.0	18.0 15.0 14.0 13.0 12.0 12.0	23.2 21.7 20.9 20.4 20.2	6.0 5.5 5.0 4.5 4.0	41.0 39.1 32.3 29.6 29.4	ns	Figure 1 Figure 2
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay Output Translation V <sub>CC</sub> (V) = 1.5	$C_L = 10pF$ $R_L = 1M\Omega$	1.0 1.10 to 1.30 1.40 to 1.60 1.65 to 1.95 2.30 to 2.70 3.00 to 3.60	5.0 4.8 4.5 4.0 3.5	14.0 11.0 10.0 9.0 8.0 8.0	16.3 14.8 14.1 13.5 13.3	4.0 3.5 3.0 2.5 2.0	20.6 19.3 18.7 18.0 17.8	ns	Figure 1 Figure 2
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay Output Translation V <sub>CC</sub> (V) = 1.8	$C_L = 10pF$ $R_L = 1M\Omega$	1.0 1.10 to 1.30 1.40 to 1.60 1.65 to 1.95 2.30 to 2.70 3.00 to 3.60	4.0 3.5 3.0 2.5 2.5	13.0 9.0 8.0 7.0 6.0 6.0	13.5 12.0 11.3 10.7 10.5	3.0 2.5 2.0 1.5 1.0	17.5 16.3 15.6 15.0 14.7	ns	Figure 1 Figure 2
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay Output Translation V <sub>CC</sub> (V) = 2.5	$C_L = 10pF$ $R_L = 1M\Omega$	1.0 1.10 to 1.30 1.40 to 1.60 1.65 to 1.95 2.30 to 2.70 3.00 to 3.60	3.0 2.5 2.0 1.5	12.0 7.0 6.0 5.0 4.0 4.0	10.9 9.4 8.6 8.0 7.8	2.5 2.0 1.5 1.0	14.3 13.1 11.4 10.8 10.5	ns	Figure 1 Figure 2
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay Output Translation V <sub>CC</sub> (V) = 3.3	$C_L = 10pF$ $R_L = 1M\Omega$	1.0 1.10 to 1.30 1.40 to 1.60 1.65 to 1.95 2.30 to 2.70 3.00 to 3.60	3.0 2.5 2.0 1.0	11.0 6.0 5.0 4.0 3.0 3.0	10.1 8.2 7.4 6.8 6.6	2.0 1.5 1.0 1.0	13.8 10.5 9.9 9.2 9.0	ns	Figure 1 Figure 2
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay Output Translation V <sub>CC</sub> (V) = 1.0	$C_L = 15pF$ $R_L = 1M\Omega$	1.0 1.10 to 1.30 1.40 to 1.60 1.65 to 1.95 2.30 to 2.70 3.00 to 3.60	16.0 15.0 14.0 13.0 12.0	28.0 27.0 26.0 25.0 24.0 23.0	43.0 41.6 40.9 40.5 40.4	12.0 11.0 10.0 9.0 8.0	44.8 43.6 47.9 47.5 41.4	ns	Figure 1 Figure 2
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay Output Translation V <sub>CC</sub> (V) = 1.2	$C_L = 15pF$ $R_L = 1M\Omega$	1.0 1.10 to 1.30 1.40 to 1.60 1.65 to 1.95 2.30 to 2.70 3.00 to 3.60	9.0 8.5 8.0 7.5 7.0	19.0 16.0 15.0 14.0 13.0	24.6 23.1 22.4 21.8 21.6	8.0 7.5 7.0 6.5 6.0	43.1 42.2 31.4 30.7 30.5	ns	Figure 1 Figure 2
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay Output Translation V <sub>CC</sub> (V) = 1.5	$C_L = 15pF$ $R_L = 1M\Omega$	1.0 1.10 to 1.30 1.40 to 1.60 1.65 to 1.95 2.30 to 2.70 3.00 to 3.60	6.0 5.8 5.5 5.0 4.5	15.0 12.0 11.0 10.0 9.0 9.0	17.2 15.7 14.9 14.3 14.2	5.5 5.0 4.5 4.0 3.5	21.5 20.3 19.6 18.9 18.7	ns	Figure 1 Figure 2
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay Output Translation V <sub>CC</sub> (V) = 1.8	$C_L = 15pF$ $R_L = 1M\Omega$	1.0 1.10 to 1.30 1.40 to 1.60 1.65 to 1.95 2.30 to 2.70 3.00 to 3.60	5.0 4.5 4.0 3.5 3.5	14.0 8.0 7.0 6.0 5.0 5.0	14.2 12.7 11.9 11.3 11.2	5.5 4.0 3.5 3.0 2.5	18.2 17.0 16.3 15.7 14.4	ns	Figure 1 Figure 2

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# AC Electrical Characteristics (Continued)

				•	$T_A = +25^{\circ}$		$T_A = -40^{\circ}$	C to +85°C	:	Figure
Symbol	Parameter	Conditions	V <sub>CC1</sub> (V)	Min.	Тур.	Max.	Min.	Max.	Units	Number
t <sub>PHL</sub>	Propagation Delay	C <sub>L</sub> = 15pF	1.0		12.0				ns	Figure 1
t <sub>PLH</sub>	Output Translation	$R_L = 1M\Omega$	1.10 to 1.30	4.0	7.0	11.3	3.5	14.9		Figure 2
	$V_{CC}(V) = 2.5$		1.40 to 1.60	3.5	6.0	9.8	3.0	13.6		
			1.65 to 1.95	3.0	5.0	9.1	2.5	12.0		
			2.30 to 2.70	2.5	4.0	8.5	2.0	11.3		
			3.00 to 3.60	2.5	4.0	8.3	2.0	11.1		
t <sub>PHL</sub>	Propagation Delay	$C_L = 15pF$	1.0		11.0				ns	Figure 1
t <sub>PLH</sub>	Output Translation	$R_L = 1M\Omega$	1.10 to 1.30	3.0	6.0	10.5	2.0	14.2		Figure 2
	$V_{CC}(V) = 3.3$		1.40 to 1.60	2.5	5.0	8.6	1.5	11.0		
			1.65 to 1.95	2.0	4.0	7.8	1.0	10.3		
			2.30 to 2.70 3.00 to 3.60	1.5 1.5	3.0 3.0	7.2 7.0	1.0 1.0	9.7 9.4		
+	Propagation Delay	C <sub>L</sub> = 30pF	1.0	1.0	34.0	7.0	1.0	0.4	ns	Figure 1
t <sub>PHL</sub> t <sub>PLH</sub>	Output Translation	$R_L = 1M\Omega$	1.10 to 1.30	19.0	32.0	48.6	15.0	55.5	115	Figure 1
TLN	$V_{CC}(V) = 1.0$		1.40 to 1.60	18.0	31.0	47.1	14.0	52.3		
	100(1)		1.65 to 1.95	17.0	30.0	46.4	13.0	50.6		
			2.30 to 2.70	16.0	29.0	45.9	12.0	49.2		
			3.00 to 3.60	15.0	28.0	45.8	10.0	49.1		
t <sub>PHL</sub>	Propagation Delay	C <sub>L</sub> = 30pF	1.0		22.0				ns	Figure 1
t <sub>PLH</sub>	Output Translation	$R_{\rm I} = 1 M\Omega$	1.10 to 1.30	11.0	19.0	29.0	10.0	46.5		Figure 2
	$V_{CC}(V) = 1.2$	-	1.40 to 1.60	10.0	18.0	27.5	9.0	42.6		
			1.65 to 1.95	9.0	17.0	26.7	8.0	36.7		
			2.30 to 2.70	8.5	16.0	26.1	7.0	36.0		
			3.00 to 3.60	8.0	16.0	26.0	6.0	35.9		
t <sub>PHL</sub>	Propagation Delay	C <sub>L</sub> = 30pF	1.0		16.0				ns	Figure 1
t <sub>PLH</sub>	Output Translation	$R_L = 1M\Omega$	1.10 to 1.30	6.0	13.0	19.8	5.5	25.3		Figure 2
	$V_{CC}(V) = 1.5$	_	1.40 to 1.60	5.8	12.0	18.3	5.0	23.0		
			1.65 to 1.95	5.5	11.0	17.6	4.5	22.4		
			2.30 to 2.70	5.0	10.0	17.0	4.0	21.7		
			3.00 to 3.60	4.5	9.0	16.8	3.5	21.5		
t <sub>PHL</sub>	Propagation Delay	$C_L = 30pF$	1.0		15.0				ns	Figure 1
t <sub>PLH</sub>	Output Translation	$R_L = 1M\Omega$	1.10 to 1.30	5.0	11.0	16.2	5.5	20.4		Figure 2
	$V_{CC}(V) = 1.8$		1.40 to 1.60	4.5	10.0	14.7	4.0	19.2		
			1.65 to 1.95	4.0	9.0	13.9	3.5	18.5		
			2.30 to 2.70	3.5	8.0	13.3	3.0	17.9		
			3.00 to 3.60	3.5	8.0	13.1	2.5	17.6		
t <sub>PHL</sub>	Propagation Delay	$C_L = 30pF$	1.0	4.0	13.0	40.7	0.5	45.0	ns	Figure 1
t <sub>PLH</sub>	Output Translation	$R_L = 1M\Omega$	1.10 to 1.30 1.40 to 1.60	4.0	8.0	12.7	3.5	15.9		Figure 2
	$V_{CC}(V) = 2.5$			3.5	7.0	11.2	3.0	14.3		
			1.65 to 1.95 2.30 to 2.70	3.0 2.5	6.0 5.0	10.5 9.9	2.5 2.0	13.6 12.8		
			3.00 to 3.60	2.5	5.0	9.7	2.0	12.5		
t <sub>PHL</sub>	Propagation Delay	C <sub>L</sub> = 30pF	1.0		12.0				ns	Figure 1
t <sub>PLH</sub>	Output Translation	$R_{\rm L} = 1M\Omega$	1.10 to 1.30	3.0	8.0	11.7	2.0	15.0		Figure 2
	$V_{CC}(V) = 3.3$	-	1.40 to 1.60	2.5	7.0	9.8	1.5	12.2		
			1.65 to 1.95	2.0	6.0	8.9	1.0	11.5		
			2.30 to 2.70	1.5	5.0	8.3	1.0	10.7		
			3.00 to 3.60	1.5	5.0	8.1	1.0	10.4		
C <sub>IN</sub>	Input Capacitance		0		2.0				pF	
C <sub>OUT</sub>	Output Capacitance		0		4.0				pF	
C <sub>PD</sub>	Power Dissipation Capacitance	$V_{I} = 0V \text{ or } V_{CC1}$ f = 10  MHz $V_{CC}/V_{CC1} = 3.6$	$V_{\rm CC}/V_{\rm CC1} = (1.0 \text{ to } 3.60)$		8.0				pF	

### **Translator Power Up Sequence Recommendations**

To insure that the system does not experience unnecessary  $I_{CC}$  current draw, bus contention, or oscillations during power up, the following guidelines should be adhered to. This device is designed with the Output pin(s) is supplied by  $V_{CC}$  and the Input pin(s) supplied by  $V_{CC1}$ . Therefore the first recommendation is to begin by powering up the input side of the device,  $V_{CC1}$ . The Input pin(s) should be ramped with or ahead of  $V_{CC1}$  or held LOW. This will guard against bus contentions and oscillations

as all Inputs and the Input  $V_{CC1}$  will be powered at the same time. The Output  $V_{CC}$  can then be powered to the voltage level that the device will be used to translate to. The Output pin(s) will then translate to logic levels dictated by the Output  $V_{CC}$  levels.

Upon completion of these steps the device can then be configured for the users desired operation. Following these steps will help to prevent possible damage to the translator device as well as other system components.

### **AC Loading and Waveforms**

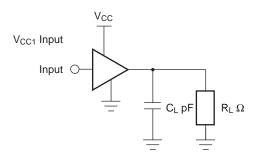


Figure 1. AC Test Circuit

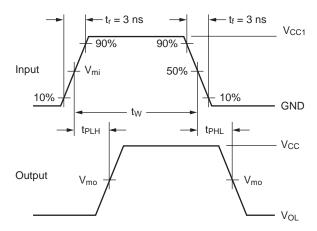


Figure 2. Waveform for Inverting and Non-Inverting Functions

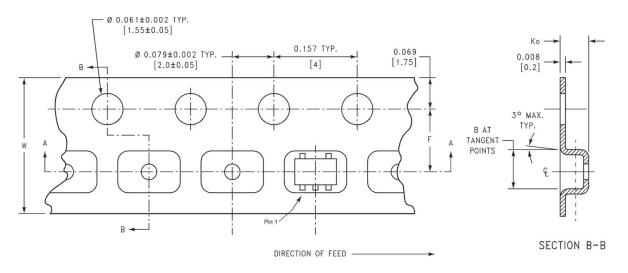
	V <sub>CC</sub>								
Symbol	3.3V ±0.3V	2.5V ±0.2V	1.8V ±0.15V	1.5V ±0.10V	1.2V ±0.10V	1.0V			
V <sub>mi</sub>	1.5V	V <sub>CC1</sub> /2							
V <sub>mo</sub>	1.5V	V <sub>CC</sub> /2							

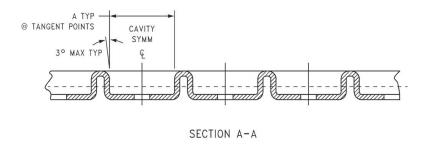
# **Tape and Reel Specification**

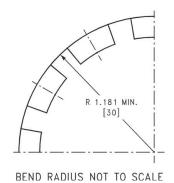
# **Tape Format for SC70**

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
P5X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

## Tape Dimensions inches (millimeters)





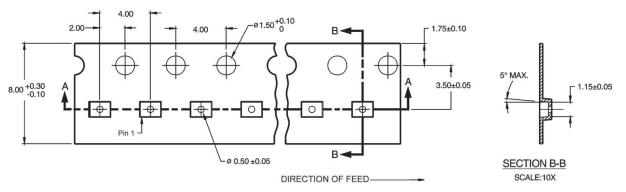


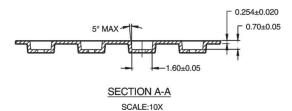
## Tape and Reel Specification (Continued)

## **Tape Format for MicroPak**

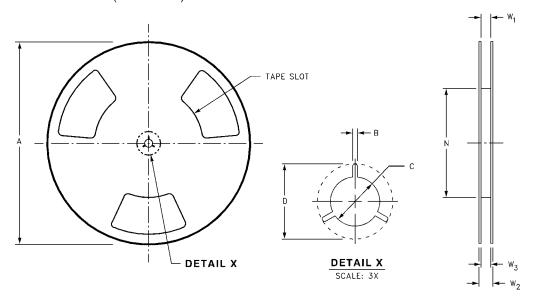
Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
L6X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

## **Tape Dimensions** millimeters



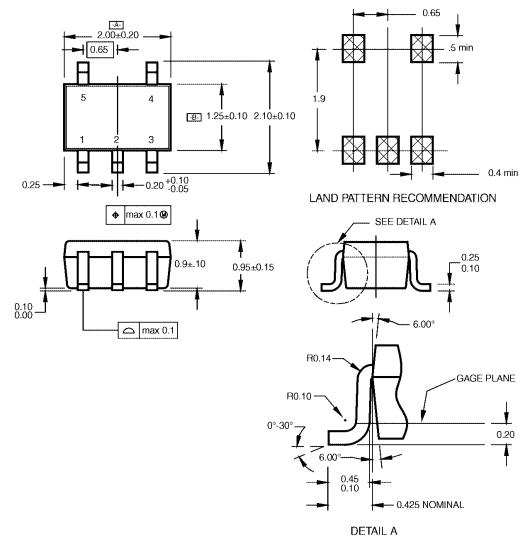


#### Reel Dimensions inches (millimeters)



Tape Size	Α	В	С	D	N	W1	W2	W3
8 mm	7.0	0.059	0.512	0.795	2.165	0.331 +0.059/-0.000	0.567	W1 +0.078/-0.039
	(177.8)	(1.50)	(13.00)	(20.20)	(55.00)	(8.40 +1.50/-0.00)	(14.40)	(W1 +2.00/-1.00)

## Physical Dimensions millimeters unless otherwise noted (Continued)



#### NOTES:

A. CONFORMS TO EIAJ REGISTERED OUTLINE DRAWING SC88A.

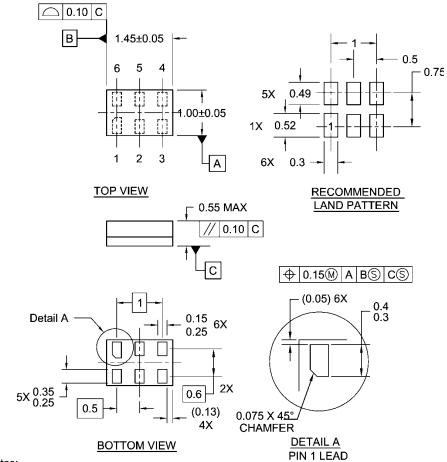
 $\ensuremath{\mathsf{B}}.$  DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.

C. DIMENSIONS ARE IN MILLIMETERS.

MAA05ARevC

5-Lead SC70, EIAJ SC-88a, 1.25mm Wide Package Number MAA05A

## Physical Dimensions millimeters unless otherwise noted (Continued)



Notes:

- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED
- 2. DIMENSIONS ARE IN MILLIMETERS
  3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

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Build it Now™	FRFET™	MicroFET™	QS™	TCM™
CoolFET™	GlobalOptoisolator™	MicroPak™	QT Optoelectronics™	TinyLogic <sup>®</sup>
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EcoSPARK™	I <sup>2</sup> C <sup>TM</sup>	MSXPro™	RapidConnect™	UHC™
E <sup>2</sup> CMOS <sup>TM</sup>	i-Lo™	OCX™	μSerDes™	UltraFET <sup>®</sup>
EnSigna™	ImpliedDisconnect™	OCXPro™	ScalarPump™	UniFET™
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		POP™	Stealth™	
		Power247™	SuperFET™	
		PowerEdge™	SuperSOT™-3	

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